8-channel analog multiplexer/demultiplexer Rev. 12 — 25 March 2016

Product data sheet

1. **General description**

The HEF4051B is an 8-channel analog multiplexer/demultiplexer with three address inputs (S1 to S3), an active LOW enable input (E), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). The device contains eight bidirectional analog switches, each with one side connected to an independent input/output (Y0 to Y7) and the other side connected to a common input/output (Z). With E LOW, one of the eight switches is selected (low-impedance ON-state) by S1 to S3. With E HIGH, all switches are in the high-impedance OFF-state, independent of S1 to S3. If break before make is needed, then it is necessary to use the enable input.

 V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (S1 to S3, and E). The V_{DD} to V_{SS} range is 3 V to 15 V. The analog inputs/outputs (Y0 to Y7, and Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. $V_{DD} - V_{EE}$ may not exceed 15 V. Unused inputs must be connected to V_{DD}, V_{SS}, or another input. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground). V_{EE} and V_{SS} are the supply voltage connections for the switches.

2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

Applications 3.

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating



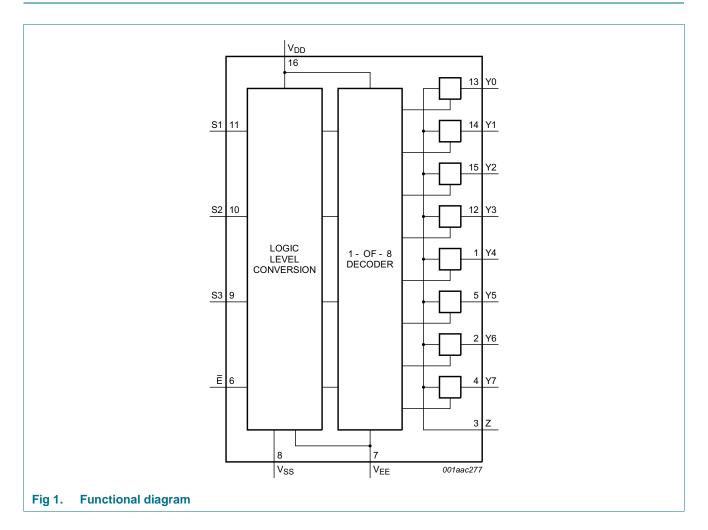
4. Ordering information

Table 1. Ordering information

All types operate from −40 °C to +125 °C.

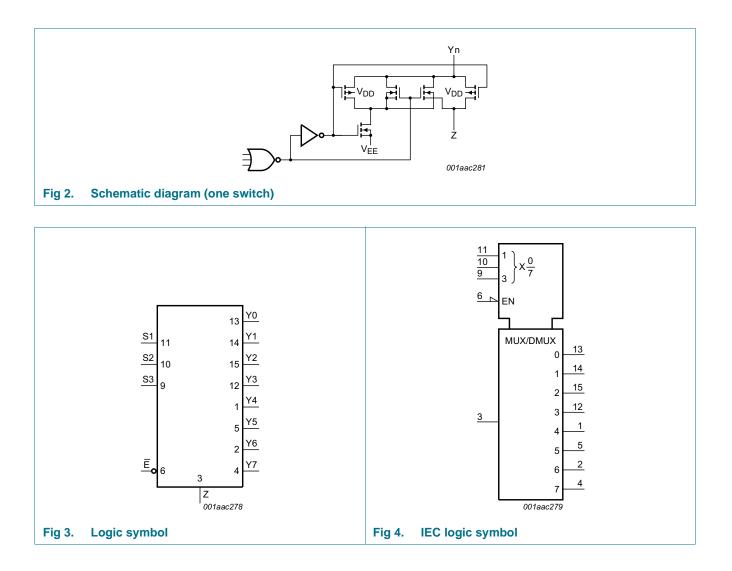
Type number	Package		
	Name	Description	Version
HEF4051BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
HEF4051BTS	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
HEF4051BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

5. Functional diagram

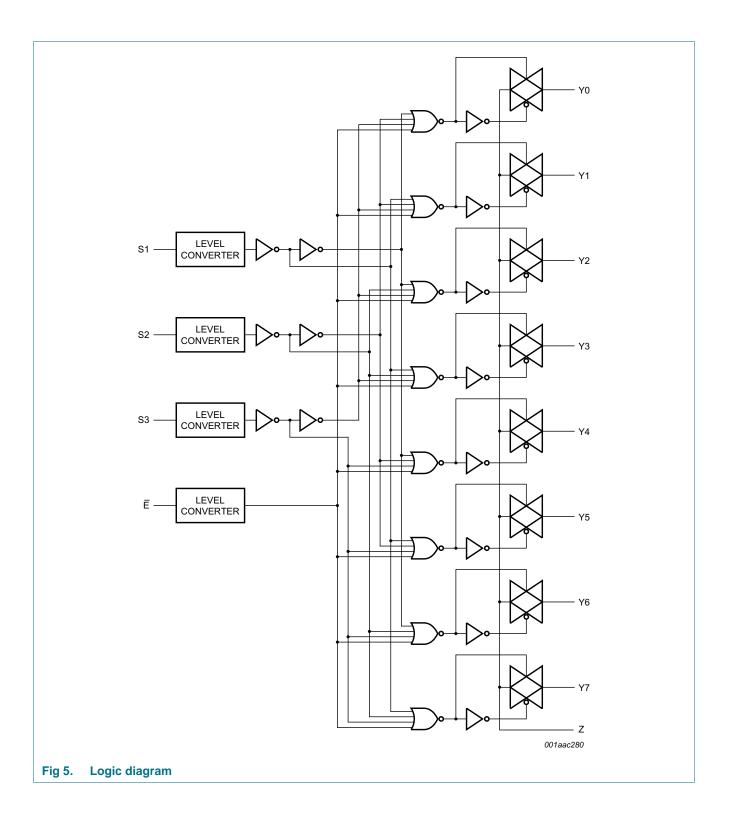


2 of 22

8-channel analog multiplexer/demultiplexer



8-channel analog multiplexer/demultiplexer

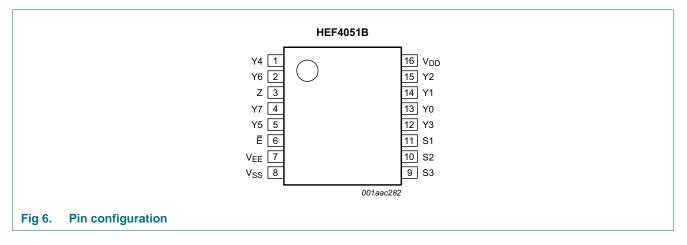


HEF4051B Product data sheet

8-channel analog multiplexer/demultiplexer

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
Ē	6	enable input (active LOW)
V _{EE}	7	supply voltage
V _{SS}	8	ground supply voltage
S1, S2, S3	11, 10, 9	select input
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	13, 14, 15, 12, 1, 5, 2, 4	independent input or output
Z	3	common output or input
V _{DD}	16	supply voltage

7. Functional description

7.1 Function table

Input				Channel ON
E	S3	S2	S1	
-	L	L	L	Y0 to Z
	L	L	Н	Y1 to Z
-	L	Н	L	Y2 to Z
-	L	Н	Н	Y3 to Z
	Н	L	L	Y4 to Z
	Н	L	Н	Y5 to Z
	Н	Н	L	Y6 to Z
-	Н	Н	Н	Y7 to Z
1	Х	Х	Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to $V_{SS} = 0 V$ (ground).

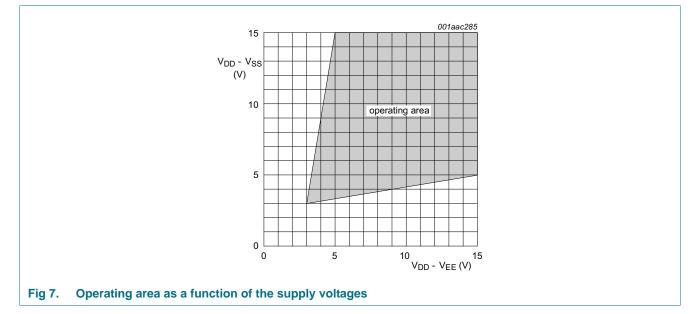
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
V _{EE}	supply voltage	referenced to V _{DD} [1]	-18	+0.5	V
I _{IK}	input clamping current	pins Sn and \overline{E} ; V _I < -0.5 V or V _I > V _{DD} + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
I _{I/O}	input/output current		-	±10	mA
I _{DD}	supply current		-	50	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+125	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$ [2]			
		SO16 package	-	500	mW
		SSOP16 package	-	500	mW
		TSSOP16 package	-	500	mW
Р	power dissipation	per output	-	100	mW

[1] To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE}.

For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.
 For SSOP16 and TSSOP16 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions										
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
V _{DD}	supply voltage	see Figure 7	3	-	15	V				
VI	input voltage		0	-	V _{DD}	V				
T _{amb}	ambient temperature	in free air	-40	-	+125	°C				
$\Delta t / \Delta V$	input transition rise and fall	$V_{DD} = 5 V$	-	-	3.75	μs/V				
	rate	V _{DD} = 10 V	-	-	0.5	μs/V				
		V _{DD} = 15 V	-	-	0.08	μs/V				



10. Static characteristics

Table 6. Static characteristics

 $V_{SS} = V_{EE} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} = -40 °C		T _{amb} =	25 °C	T _{amb} =	85 °C	T _{amb} = 125 °C		Unit
				Min	Max	Min	Мах	Min	Max	Min	Max	
V _{IH}	HIGH-level	I ₀ < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	I _O < 1 μA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
lı	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ

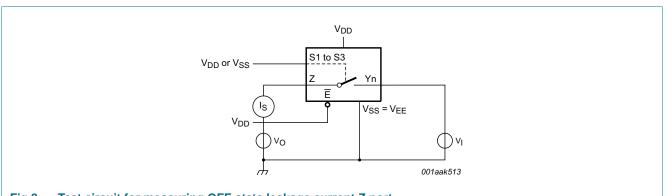
8-channel analog multiplexer/demultiplexer

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	25 °C	T _{amb} =	= 85 °C	$T_{amb} = 125 \circ C$		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I _{S(OFF)}	OFF-state leakage current	Z port; all channels OFF; see <u>Figure 8</u>	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see <u>Figure 9</u>	15 V	-	-	-	200	-	-	-	-	nA
I _{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	-	150	μA
			10 V	-	10	-	10	-	300	-	300	μA
			15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance	Sn, \overline{E} inputs	-	-	-	-	7.5	-	-	-	-	pF

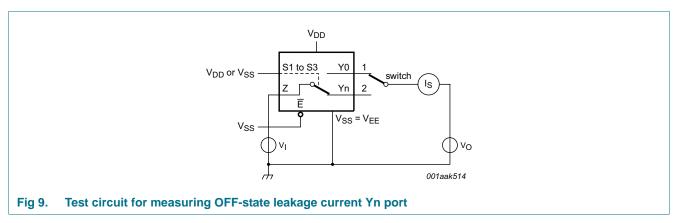
Table 6. Static characteristics ...continued

 $V_{SS} = V_{EE} = 0$ V; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

10.1 Test circuits







8 of 22

8-channel analog multiplexer/demultiplexer

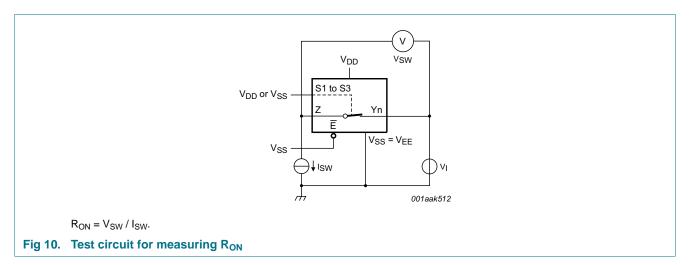
10.2 ON resistance

Table 7. ON resistance

 $T_{amb} = 25 \ ^{\circ}C; I_{SW} = 200 \ \mu A; V_{SS} = V_{EE} = 0 \ V.$

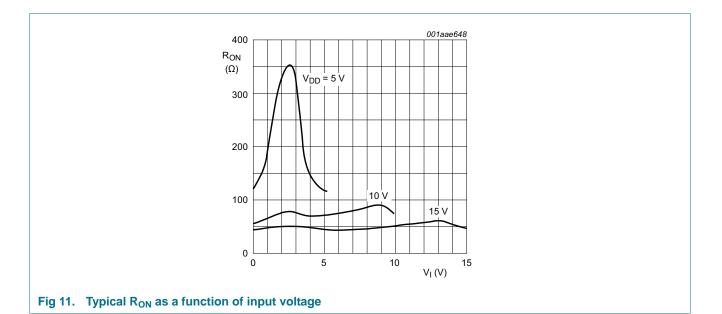
Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R _{ON(peak)}	ON resistance (peak)	$V_I = 0 V \text{ to } V_{DD} - V_{EE};$	5 V	350	2500	Ω
		see Figure 10 and Figure 11	10 V	80	245	Ω
			15 V	60	175	Ω
R _{ON(rail)}	ON resistance (rail)	$V_I = 0 V$; see <u>Figure 10</u> and <u>Figure 11</u>	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD} - V_{EE};$	5 V	120	365	Ω
		see Figure 10 and Figure 11	10 V	65	200	Ω
			15 V	50	155	Ω
ΔR_{ON}	ON resistance mismatch	$V_I = 0 V$ to $V_{DD} - V_{EE}$; see Figure 10	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

10.2.1 ON resistance waveform and test circuit



HEF4051B

8-channel analog multiplexer/demultiplexer



11. Dynamic characteristics

Table 8. Dynamic characteristics

 $T_{amb} = 25 \text{ °C}; V_{SS} = V_{EE} = 0 \text{ V}; \text{ for test circuit see } Figure 15.$

Symbol	Parameter	Conditions	V _{DD}	Тур	Max	Unit
t _{PHL}	HIGH to LOW propagation delay	Yn, Z to Z, Yn; see Figure 12	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 13	5 V	150	300	ns
			10 V	60	120	ns
			15 V	45	90	ns
t _{PLH}	LOW to HIGH propagation delay	Yn, Z to Z, Yn; see Figure 12	5 V	15	30	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to Yn, Z; see Figure 13	5 V	150	300	ns
			10 V	65	130	ns
			15 V	45	90	ns
t _{PHZ}	HIGH to OFF-state	E to Yn, Z; see Figure 14	5 V	120	240	ns
	propagation delay		10 V	90	180	ns
			15 V	85	170	ns
t _{PZH}	OFF-state to HIGH	E to Yn, Z; see Figure 14	5 V	140	280	ns
	propagation delay		10 V	55	110	ns
			15 V	40	80	ns
t _{PLZ}	LOW to OFF-state	E to Yn, Z; see Figure 14	5 V	145	290	ns
	propagation delay		10 V	120	240	ns
			15 V	115	230	ns

8-channel analog multiplexer/demultiplexer

$T_{amb} = 25 \ ^{\circ}\text{C}; V_{SS} = V_{EE} = 0 \ V; \text{ for test circuit see } Figure 15.$									
Symbol	Parameter	Conditions	V _{DD}	Тур	Max	Unit			
	OFF-state to LOW	E to Yn, Z; see Figure 14	5 V	140	280	ns			
	propagation delay		10 V	55	110	ns			
			15 V	40	80	ns			

Table 8. Dynamic characteristics ...continued

11.1 Waveforms and test circuit

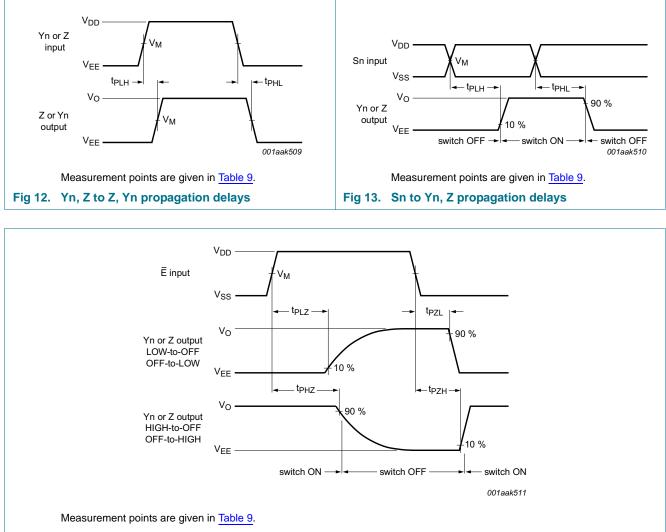


Fig 14. Enable and disable times

Table 9. Measurement points

Supply voltage	Input	Output		
V _{DD}	V _M	V _M		
5 V to 15 V	0.5V _{DD}	0.5V _{DD}		

HEF4051B Product data sheet

8-channel analog multiplexer/demultiplexer

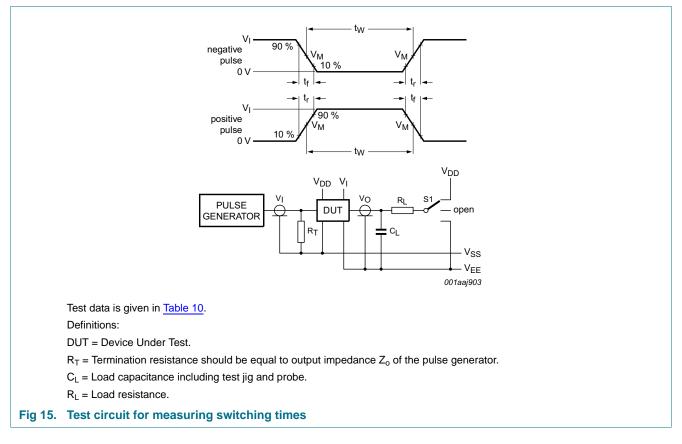


Table 10. Test data

	Input			Load	.oad S1 position						
Yn, Z Sn		Sn and \overline{E}	t _r , t _f	V _M	CL	RL	t _{PHL} [1]	t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	other
	V_{DD} or V_{EE}	$V_{\text{DD}} \text{ or } V_{\text{SS}}$	≤ 20 ns	0.5V _{DD}	50 pF	10 kΩ	V_{DD} or V_{EE}	V _{EE}	V _{EE}	V _{DD}	V_{EE}

[1] For Yn to Z or Z to Yn propagation delays use V_{EE}. For Sn to Yn or Z propagation delays use V_{DD}.

8-channel analog multiplexer/demultiplexer

11.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

 $V_{\text{SS}} = V_{\text{EE}} = 0$ V; $T_{\text{amb}} = 25$ °C.

Symbol	Parameter	Conditions	V _{DD}	Тур	Max	Unit
THD	total harmonic distortion	see Figure 16; $R_L = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1 \text{ kHz}$	5 V [0.25	-	%
			10 V	0.04	-	%
			15 V	0.04	-	%
f _(-3dB)	-3 dB frequency response	see Figure 17; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$; channel ON; $V_I = 0.5V_{DD}$ (p-p)	5 V [<u>l</u> 13	-	MHz
			10 V	<u>1</u> 40	-	MHz
			15 V	<u>1</u> 70	-	MHz
α_{iso}	isolation (OFF-state)	see Figure 18; $f_i = 1 \text{ MHz}$; $R_L = 1 \text{ k}\Omega$; $C_L = 5 \text{ pF}$; channel OFF; $V_1 = 0.5V_{DD} \text{ (p-p)}$	10 V 🧕	<u>1]</u> –50	-	dB
V _{ct}	crosstalk voltage	digital inputs to switch; see Figure 19; $\frac{R_L}{E} = 10 \text{ k}\Omega$; $C_L = 15 \text{ pF}$; E or Sn = V _{DD} (square-wave)	10 V	50	-	mV
Xtalk	crosstalk	between switches; see Figure 20; $f_i = 1 \text{ MHz}; R_L = 1 \text{ k}\Omega;$ $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V [<u>1]</u> –50	-	dB

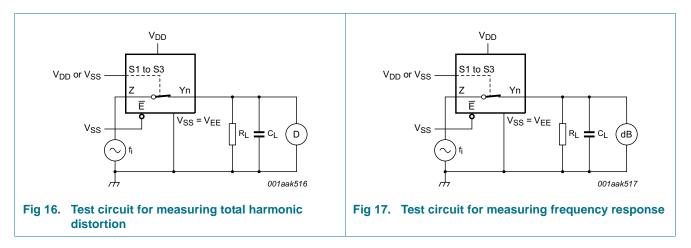
[1] f_i is biased at 0.5 V_{DD}; V_I = 0.5V_{DD} (p-p).

Table 12.Dynamic power dissipation PD

 P_D can be calculated from the formulas shown; $V_{EE} = V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

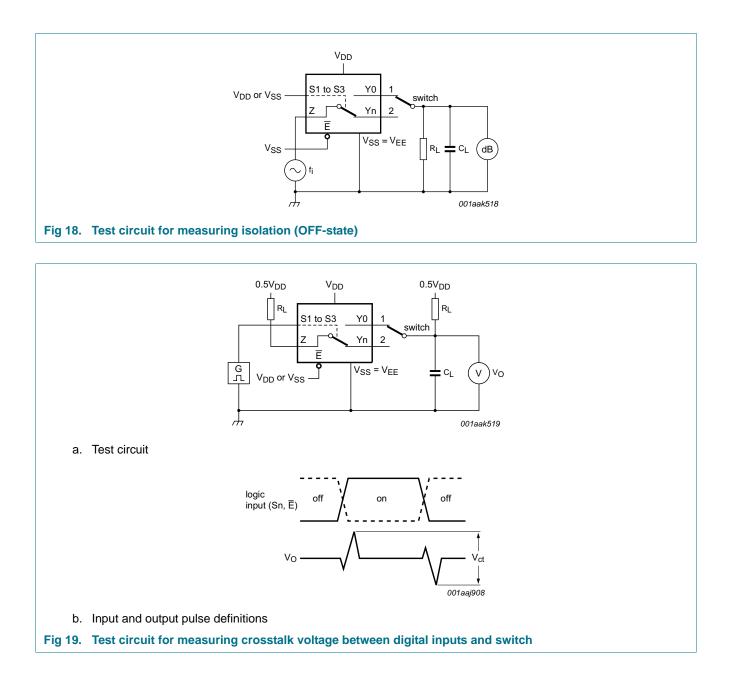
Symbol	Parameter	V _{DD}	Typical formula for P_D (μ W)	where:
P _D	dynamic power dissipation	5 V	$P_D = 1000 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$	$f_i = input frequency in MHz;$
		10 V	$P_D = 5500 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$	f _o = output frequency in MHz;
		15 V	$P_{D} = 15000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	C_L = output load capacitance in pF;
				V _{DD} = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

11.2.1 Test circuits



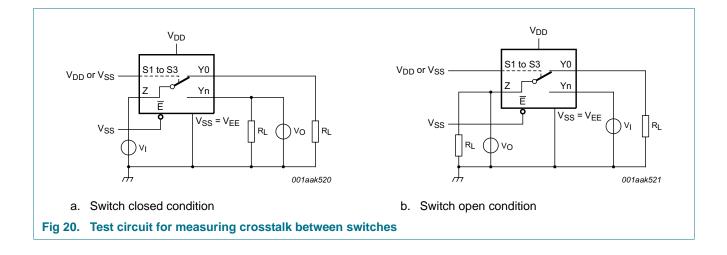
HEF4051B

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12. Package outline

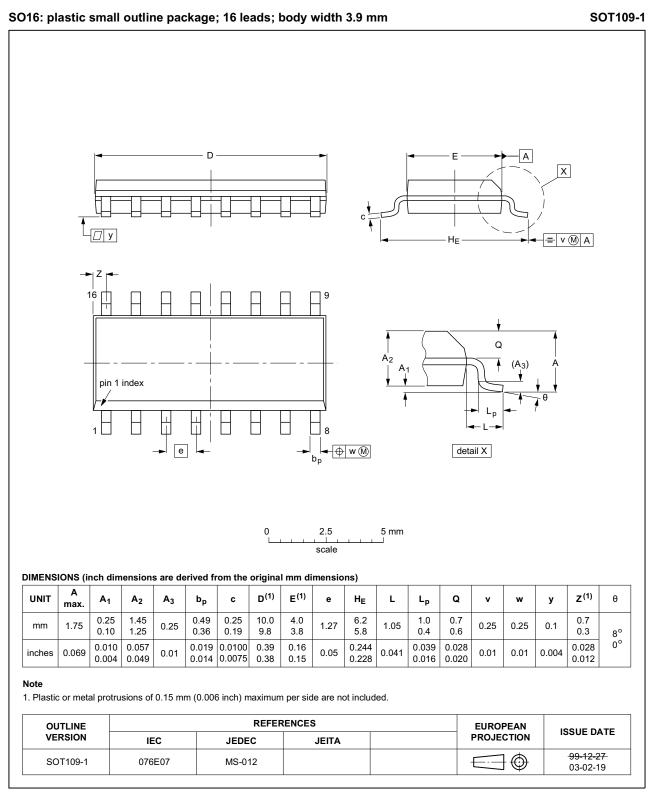


Fig 21. Package outline SOT109-1 (SO16)

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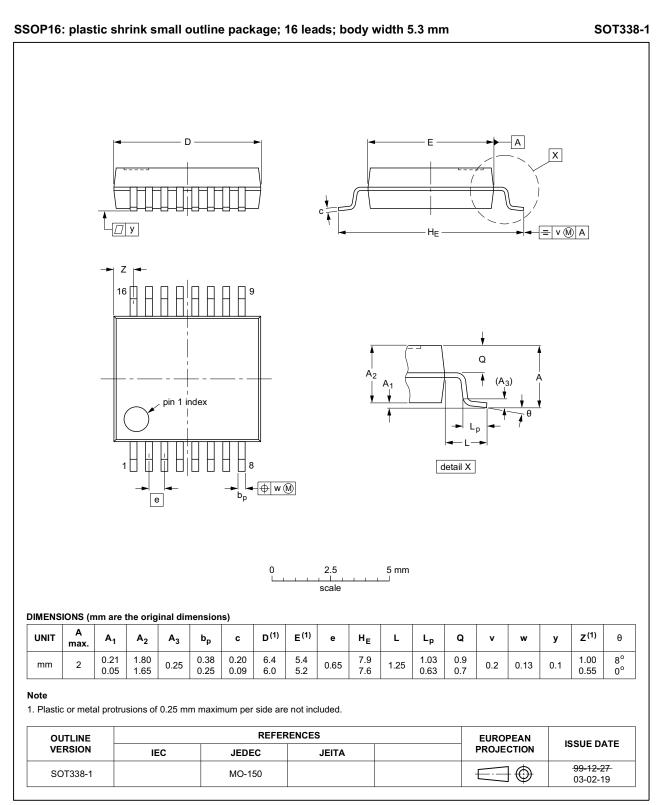


Fig 22. Package outline SOT338-1 (SSOP16)

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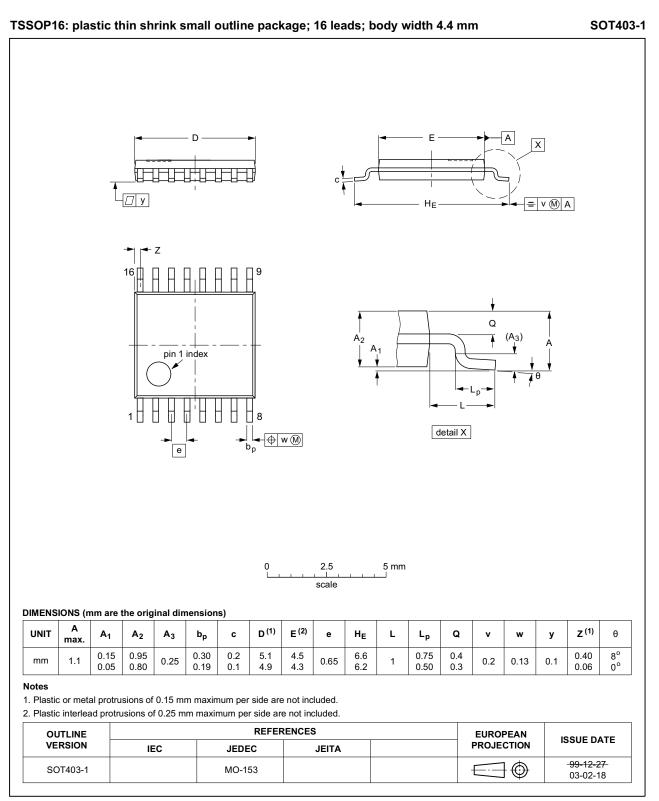


Fig 23. Package outline SOT403-1 (TSSOP16)

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13. Abbreviations

Table 13. Abbreviations		
Acronym	Description	
DUT	Device Under Test	

14. Revision history

Table 14. Revision his	story				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
HEF4051B v.12	20160325	Product data sheet	-	HEF4051B v.11	
Modifications:	 Type number 	er HEF4051BP (SOT38-4) rem	noved.		
HEF4051B v.11	20140911	Product data sheet	-	HEF4051B v.10	
Modifications:	<u>Figure 19</u> : Test circuit modified				
HEF4051B v.10	20111117	Product data sheet	-	HEF4051B v.9	
Modifications: • Legal pages updated.				·	
	 Changes in 	"General description", "Featur	es and benefits" and	"Applications".	
HEF4051B v.9	20100325	Product data sheet	-	HEF4051B v.8	
HEF4051B v.8	20100301	Product data sheet	-	HEF4051B v.7	
HEF4051B v.7	20091127	Product data sheet	-	HEF4051B v.6	
HEF4051B v.6	20090924	Product data sheet	-	HEF4051B v.5	
HEF4051B v.5	20090826	Product data sheet	-	HEF4051B v.4	
HEF4051B v.4	20050112	Product data sheet	-	HEF4051B_CNV v.3	
HEF4051B_CNV v.3	19950101	Product specification	-	HEF4051B_CNV v.2	
HEF4051B_CNV v.2	19950101	Product specification	-	-	

Table 14. Revision history

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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17. Contents

1	General description 1
2	Features and benefits 1
3	Applications 1
4	Ordering information 2
5	Functional diagram 2
6	Pinning information 5
6.1	Pinning 5
6.2	Pin description 5
7	Functional description 6
7.1	Function table 6
8	Limiting values 6
9	Recommended operating conditions7
10	Static characteristics 7
10.1	Test circuits
10.2	ON resistance 9
10.2.1	ON resistance waveform and test circuit 9
11	Dynamic characteristics 10
11.1	Waveforms and test circuit 11
11.2	Additional dynamic parameters 13
11.2.1	Test circuits
12	Package outline 16
13	Abbreviations 19
14	Revision history 19
15	Legal information 20
15.1	Data sheet status 20
15.2	Definitions 20
15.3	Disclaimers
15.4	Trademarks
16	Contact information 21
17	Contents 22

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